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SEMI Reports Third Quarter 2016 Worldwide Semiconductor Equipment Figures; Billings \$11.0 Billion

SAN JOSE, Calif. – December 5, 2016 – SEMI, the global industry association representing more than 2,000 companies in the electronics manufacturing supply chain, today reported that worldwide semiconductor manufacturing equipment billings reached US\$11.0 billion in the third quarter of 2016. The billings figure is 5 percent higher than the second quarter of 2016 and 14 percent higher than the same quarter a year ago. The data is gathered jointly with the Semiconductor Equipment Association of Japan (SEAJ) from over 95 global equipment companies that provide data on a monthly basis.

Worldwide semiconductor equipment bookings were \$11.3 billion in the third quarter of 2016. The figure is 30 percent higher than the same quarter a year ago and 5 percent lower than the bookings figure for the second quarter of 2016.

The quarterly billings data by region in billions of U.S. dollars, quarter-over-quarter growth and year-over-year rates by region are as follows:

| | 3Q2016 | 2Q2016 | 3Q2015 | 3Q2016/2Q16 (Qtr-over-Qtr) | 3Q16/3Q2015 (Year-over-Year) |
|----------------------|--------------|--------------|-------------|-------------------------------|---------------------------------|
| Taiwan | 3.46 | 2.73 | 2.85 | 27% | 22% |
| Korea | 2.09 | 1.53 | 1.56 | 36% | 34% |
| China | 1.43 | 2.27 | 1.70 | -37% | -16% |
| Japan | 1.29 | 1.05 | 1.43 | 22% | -10% |
| Rest of World | 1.13 | 1.31 | 0.58 | -14% | 95% |
| North America | 1.05 | 1.20 | 1.18 | -12% | -11% |
| Europe | 0.53 | 0.37 | 0.34 | 42% | 57% |
| Total | 10.98 | 10.46 | 9.64 | 5% | 14% |

Totals may not add due to rounding; Source: SEMI/SEAJ

The Equipment Market Data Subscription (EMDS) from SEMI provides comprehensive market data for the global semiconductor equipment market. A subscription includes three reports: the monthly SEMI Book-to-Bill Report, which offers an early perspective of the trends in the equipment market; the monthly Worldwide Semiconductor Equipment Market Statistics (WWSEMS), a detailed report of semiconductor equipment bookings and billings for seven regions and over 22 market segments; and the SEMI Semiconductor Equipment Forecast, which provides an outlook for the semiconductor equipment market. For more information or to subscribe, please contact SEMI customer service at 1.877.746.7788 or 1.877.746.7788 FREE (toll free in the U.S.) or 1.408.943.6901 or 1.408.943.6901 FREE (International Callers). More information also is available online: www.semi.org/en/MarketInfo/EquipmentMarket (<http://www.semi.org/en/MarketInfo/EquipmentMarket>).

About SEMI

SEMI® connects more than 2,000 member companies and more than a quarter-million professionals worldwide to advance the science and business of electronics manufacturing. SEMI members are responsible for the innovations in materials, design, equipment, software, and services that enable smarter, faster, more powerful, and more affordable electronic products. Since 1970, SEMI has built connections that have helped its members grow, create new markets, and address common industry challenges together. SEMI maintains offices in Bangalore, Beijing, Berlin, Brussels, Grenoble, Hsinchu, Moscow, San Jose, Seoul, Shanghai, Singapore, Tokyo, and Washington, D.C. For more information about SEMI, visit www.semi.org (<http://www.semi.org>) and follow SEMI on LinkedIn (<https://www.linkedin.com/company/semi>) and Twitter (<https://twitter.com/semiexpos>).

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